

ELECTRONIC SOLDERING MATERIALS

MANUFACTURERS SINCE 1930

FULLY COMMITTED TO QUALITY AND SERVICE EXCELLENCE

TIN/LEAD ELECTRONICS SOLDER WIRE BROFIL In accordance with norm UNE-EN -ISO 9453:2015

BROFIL is a reliable and high-quality lead-containing flux-cored soft solder wire alloy.

APPLICATION: Developed for general hand and automated soldering applications, component insertion and touch-up for surface mount technology used in the electronics assembly industries where a low melting point alloy has been specified. Alloys compliant with the current regulation EN ISO 9653:2015, EN 61190-1-3:2007 and Flux compliant with standard EN-ISO 29454-1 / J-STD-004.

		Alloy comp	osition %		Re	sin	Ro	sin		
	Product name	Sn Cu Ag	Pb	EN-ISO 9453	B1.1 With halogens	B1.2 Halogen free	B2.1 With halogens	B2.2 Halogen free	Melting range ^e C Solidus-Liquidus	
	Brofil 25	25	74&Sb1	136	√	√	√	√	185 - 263º C	
	Brofil 30	30	70	116	√	√	√	√	183 - 255º C	
alloys	Brofil 40	40	60	114	√	√	√	√	183 - 238º C	
dal	Brofil 50	50	50	111	√	√	√	√	183 - 215º C	
Leaded	Brofil 60	60	40	103	√	√	√	√	183 - 190º C	
ੁ	Brofil 63	63	37	102	√	√	√	√	183º C eutectic	
	Brofil 80	80	20	-	√	√	√	√	-	
			-		REM1	REMO	ROM1	ROMO		
		Libre de colofonia								

*Sizes : From 0,5mm to 6mm. Supplied on: Reels from 100g. to 4 Kg. Libre de colofonia Flux compatible EN-ISO 29454-1 / J-STD-004 Flux compliant with EN ISO 29454-1 and J-STD-004

*Other alloys and fluxes are available upon request.

TIP CLEANER Halogen-free medium for tip-activation of soldering irons

The TIP CLEANER (completely made of natural materials.), was developed to remove scaling and residues from soldering tips and irons. It is compared to other common tip cleaners, it is activated without halogen which enables good tinning results.





• Cared soldering tips last longer!

*All our products can be supplied with analysis or Certificate of Conformity.

LEAD-FREE ELECTRONICS SOLDER WIRE ECO In accordance with norm UNE-EN -ISO 9453:2015 and RoHS directive

Our ECO product range (solid and flux cored wires) stands out for being of top quality and ecological friendly.

Applicaton: developed for general hand and automated soldering applicatons, component insertion and touch-up for surface mount technology for electronics assembly industries.

Alloys compliant with the current regulation EN ISO 9653:2015, EN 61190-1-3:2007 and RoHS directive. Flux compliant EN-ISO 29454-1 / J-STD-004.



							Flux cores a			
	All	oy com	position	%		Re	sin	Rosin		
Product name	Sn	Cu	Ag	Pb	EN-ISO 9453	B1.1 With halogens	B1.2 Halogen free	B2.1 With halogens	B2.2 Halogen free	Melting range ^e C Solidus-Liquidus
ECO 1	99.3	0.7		Free	401	√	√	√	√	222º C eutectic
ECO 2	97		3	Free	702	√	√	√	√	221 - 224º C
ECO 3	97	3		Free	402	√	√	√	√	227 - 310º C
ECO 2 ECO 3 ECO 4 ECO 5	96.5	0.5	3	Free	711	√	√	√	√	217 - 220º C
ECO 5	99	0.7	0.3	Free	501	√	√	√	√	217 - 227º C
ECO 6	95.5	0.7	3.8	Free	713	√	√	√	√	217 - 226º C
ECO 7	96.3		3.7	Free	701	√	√	~	√	221 - 228º C
Sn100	99.9			Free	—					232 - mp ^b ⁰ C

REM1

* FDS & MSDS for each product are available upon request.

Free colophonia Flux compatible EN-ISO 29454-1 / J-STD-004 Flux compliant with EN ISO 29454-1 and J-STD-004

ROM1

ROM0

REMO

		Classific	ation per	Flux cores range	
	Product name	EN-ISO 29454-1	J-STD-004	Description	
1	B2.2	1.1.3.B	ROMO	 Halide-free rosin for all electronic assembly applications. Fast wetting and good spreading. Minimal non-corrosive and clear post-soldering residues which can be safely left without the need to remove them. 	
cores & flux content 4 2.5%	B2.1	· 1.1.2.B	ROM1	 Activated rosin (contains halides) for quick-spreading and difficult to solder surfaces to join copper, nickel, brass and bronze. Also suitable on robotic soldering, rework and repair applications. Low post-soldering residues that are hard and which can be safely left without the need to remove them. 	
Jo N	B1.2	1.2.3.B	REMO	• Halide-free resin. Good spread on cooper, brass and nickel. Low spitting.	
	B1.1	1.2.2.B	REM1	• Activated resin (contains halides). Developed to cope with the higher process temperatures at lead-free soldering.	
*Other alloys	and flu	xes are (available	upon request.	

FLUXES In accordance with RoHS directive

We offers a wide range of fluxes. NO- Cleans, minimal residues, excellent activity and very good soldering properties. These fluxes are formulated to suit many different processes during the use of soldering in electronic and industrial applications. All our fluxes are compatible with RoHS directive and with lead-free alloys.





Packaging flux pastes: Gax-50: Syringe 5ml or 10ml. NC-260/RF EO: Syringe10ml. Others: Plastic jar 100g or 250g.



Packaging flux: Flux pen: Plastic sleeve with pressure metering system with 8 ml10ml. Liquid flux: Garrafe 5I. and 20I.

SOLDER PASTES In accordance with RoHS directive

A complete range of solder pastes formulated to meet the critical demands of micro-electronics production and all printed circuit applications.

	Product name	No clean	Halide free	Low Voiding	Type flux
Lead	BROPASTE Sn96.5Cu0.5Ag3				ROL1/ROL0/ORH0
Free	BROPASTE Sn99Cu0.7Ag0.3				ROL1/ROL0
Tin	BROPASTE 62.36.2				ROL1/ORM1
Lead	BROPASTE 63.37				ROL1/ORM1

APPLICATIONS:

Universal SMD Solder Pastes. Wide Range of Applications and PCB designs.



ELECTRONIC BARS ECO & BROFIL In accordance with norm UNE-EN -ISO 9453:2015 and RoHS directive

ECO Lead-Free and BROFIL Tin/Lead bars are for wave and dip soldering electronics assembly processes.

ECO & BROFIL alloys are produced from high purity raw materials and following a special manufacturing process that ensures minimal impurity levels and solder defects on the finished products. This results in less dross formation and rework, longer useful life of the solder bath and thus leads to a higher productvity in the printed circuit board assembly.

		Alle	oy comp	oositior	n %		Avail		
	Product name	Sn	Cu	Ag	Pb	EN-ISO 9453	Bar & Stick	Solid wire	Melting range ^o C Solidus-Liquidus
	ECO 1	99.3	0.7		Free	401	√	√	222º C eutectic
	ECO 2	97		3	Free	702	√	√	221 - 224º C
Lead-free alloys	ECO 3	97	3		Free	402	√	√	227 - 310º C
ie al	ECO 4	96.5	0.5	3	Free	711	√	√	217 - 220º C
l-fre	ECO 5	99	0.7	0.3	Free	501	√	√	217 - 227º C
-eac	ECO 6	95.5	0.7	3.8	Free	713	√	√	217 - 226º C
	ECO 7	96.3		3.7	Free	701	√	√	221 - 228º C
	Sn100	99.9			Free	-	√		232 - mp ^b º C
	Brofil 25	25			74&Sb1	136	√	√	185 - 263º C
S	Brofil 30	30			70	116	√	√	183 - 255º C
Leaded alloys	Brofil 40	40	-		60	114	√	√	183 - 238º C
a a	Brofil 50	50	-		50	111	√	√	183 - 215º C
ade	Brofil 60	60	-		40	103	√	√	183 - 190º C
<u> </u>	Brofil 63	63	_		37	102	√	√	183º C eutectic
	Brofil 80	80			20	-	√	√	-



*Other alloys and formats (solder wire reels for selective soldering, pellets, etc.) are available upon request.

CLEANER- HALOGEN FREE SCATTER SALT

This product is special for cleaning the layer of metallic oxides created on tin bath surface. By using our halogen-free scatter salt, most of the metallic components in the dross will be dissolved and therefore can be returned to the process.

- Perfect results
- Halogen free
- Strong cleaning power



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